

Scintilla Soldering Course

16 September 2025





Planning

Lecture

- → What is soldering?
- ** Electronic components
- Soldering techniques
- → Finding and fixing errors
- Principles of the kit

Practical

- ♣ Planning your lay-out
- Assembling your lay-out
- → Soldering the components
- Testing
- Debugging
- **₩** Etc.



What is soldering?

Breadboard

- For testing
- Temporary
- **₩** Fragile
- Not suitable for high frequencies

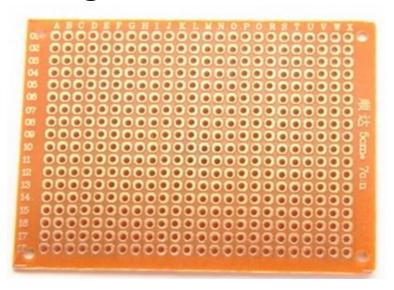
Soldering

- Permanent
- Rigid and proper electrical connections
- ◆ Durable

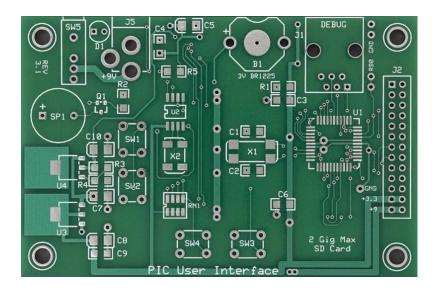


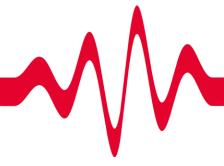
What is soldering?

Through-hole (THT)



Surface mount (SMD)



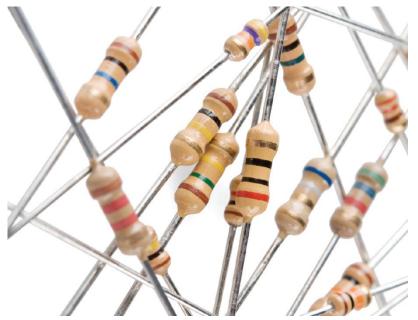


What to take into account?

Electronic Components

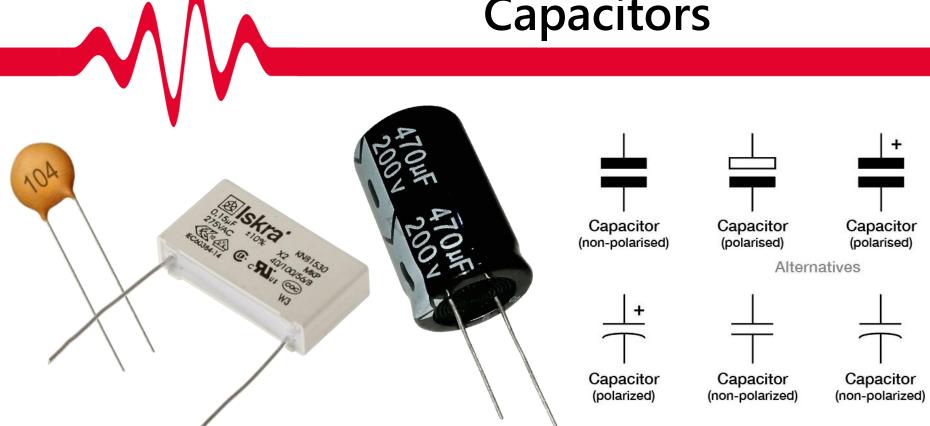


Resistors









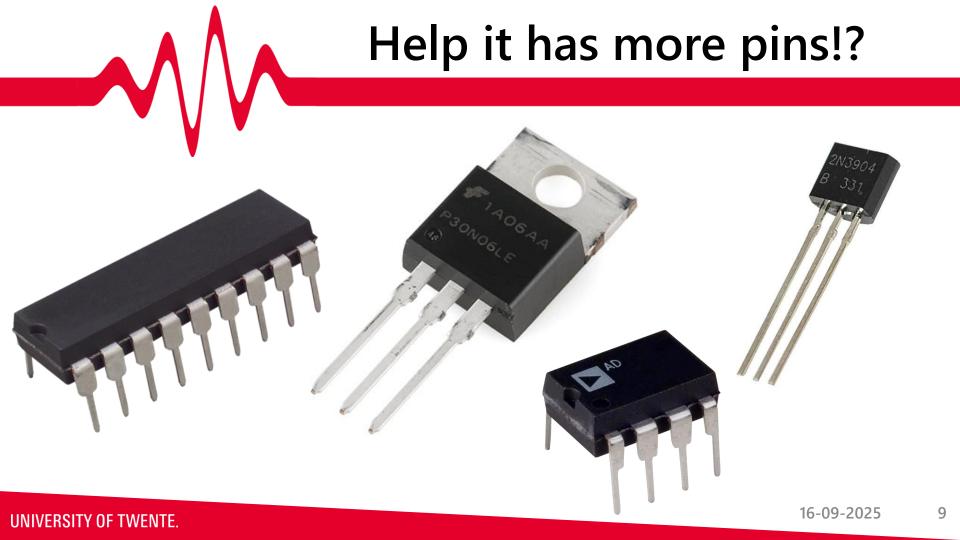


Polarized Components

Only possible to connect in 1 direction

- ♣ Long side usually '+'
- → White stripe usually '-'







Reading Datasheets

What can you find?

- Maximum ratings
- Common applications
- ** Electrical characteristics
- Pin layout(!)



MJE3055T

General Purpose and Switching Applications

DC Current Gain Specified to I_C =10A

High Current Gain-Bandwidth Product: f_T = 2MHz (Min.)



1.Base 2.Collector 3.Emitter

NPN Silicon Transistor

Absolute Maximum Ratings T_C=25°C unless otherwise noted

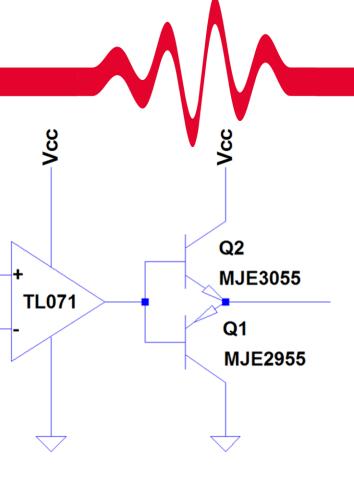
Symbol	Parameter	Value	Units
V _{CBO}	Collector -Base Voltage	70	V
V _{CEO}	Collector-Emitter Voltage	60	V
V _{EBO}	Emitter-Base Voltage	5	V
I _C	Collector Current	10	Α
I _B	Base Current	6	Α
Pc	Collector Dissipation (T _C =25°C)	75	W
Pc	Collector Dissipation (T _a =25°C)	0.6	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	- 55 ~ 150	°C

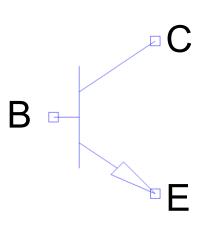
Electrical Characteristics To=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = 200mA, I _B = 0	60		V
I _{CEO}	Collector Cut-off Current	V _{CE} = 30V, I _B = 0		700	μA
ICEX1	Collector Cut-off Current	V _{CE} = 70V, V _{BE} (off) = -1.5V V _{CE} = 70V, V _{BE} (off) = -1.5V @ T _C = 150°C		5	mA mA
I _{EBO}	Emitter Cut-off Current	V _{EB} = 5V, I _C = 0		5	mA
h _{FE}	*DC Current Gain	V _{CE} = 4V, I _C = 4A V _{CE} = 4V, I _C = 10A	20 5	100	
V _{CE} (sat)	*Collector-Emitter Saturation Voltage	I _C = 4A, I _B = 0.4A I _C = 10A, I _B = 3.3A		1.1 8	V
V _{BE} (on)	"Base-Emitter On Voltage	V _{CE} = 4V, I _C = 4A		1.8	V
fτ	Current Gain Bandwidth Product	V _{CE} = 10V, I _C = 500mA	2		MHz

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Transistor

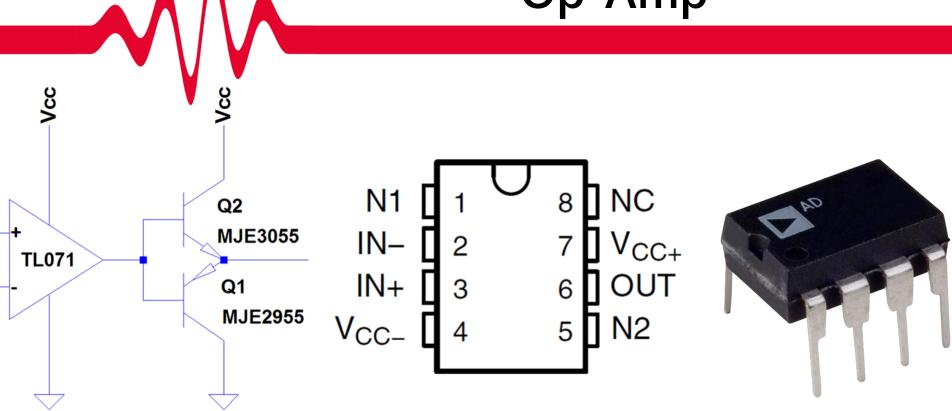




Heat sink might be connected to one of the pins!



Op-Amp





IC Sockets

What are they used for?

- ** Easy to replace components
- Prevents overheating during soldering





Do's and don'ts

Soldering techniques

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Sorts of tin

→ Unleaded solder

- ~330°C
- Has an expiration date
- Uses flux core

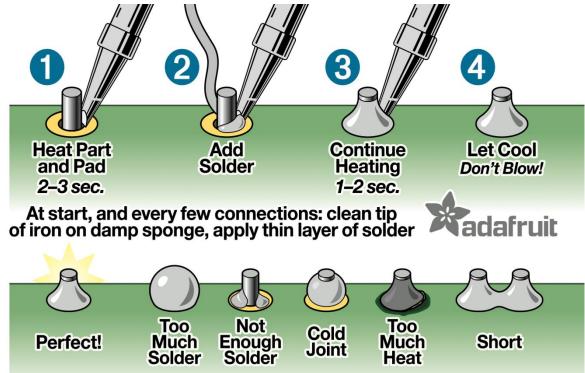
~230°C

- Higher melting point
- Toxic fumes
- Easier to solder
- ♣ Flux
 - 'Repairs' oxidized metals

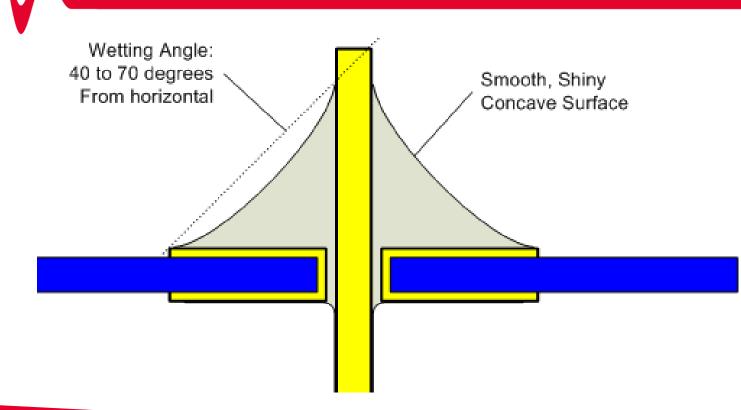




How to do it correctly



Correct Joint

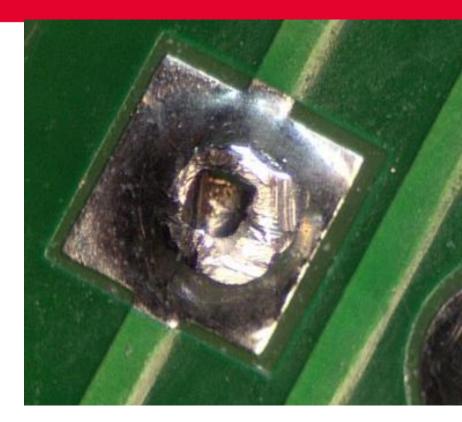




Cold Joint

Cause: cold metal

Solution: Reheat (and add new solder/flux)





Dry Joint

Cause: Movement

during cooling

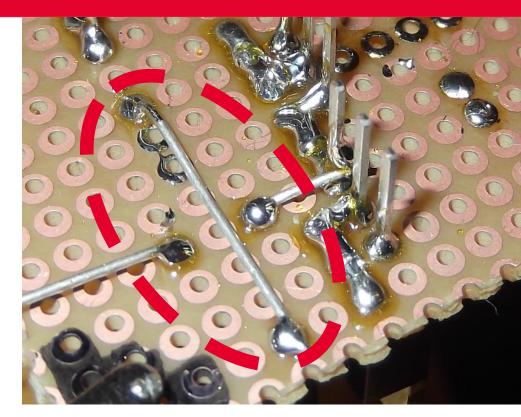
Solution: Reheat



Connections

Using Component Legs

- Use the components to make a bridge

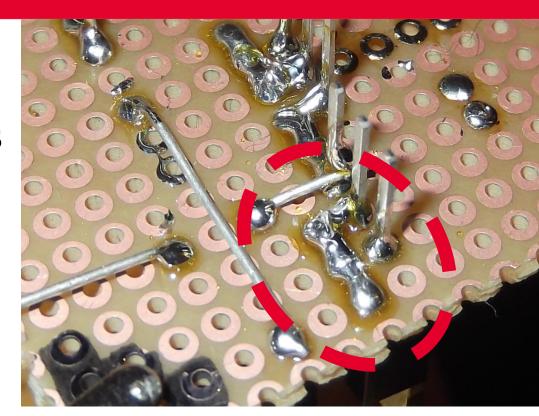


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Connections

Using Solder Bridges

- Connects nearby components
- Use tin to make the connection





Connections

Using Wire Bridges

- Covers large distances
- Makes circuit chaotic





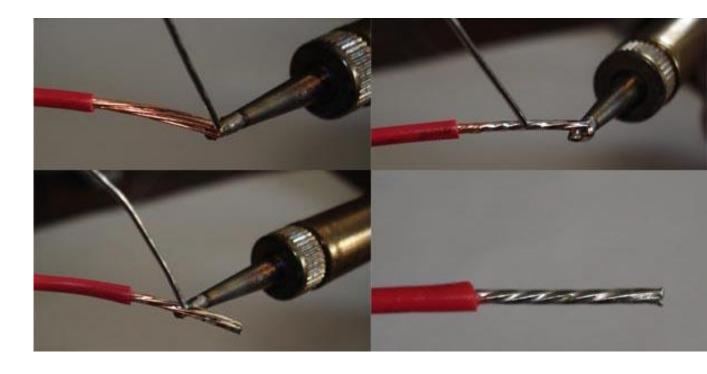
Fitting Components

Keep it tidy!

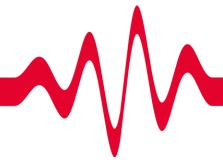
- Make sure components are flush with the PCB
- Avoid using wires
- Do not connect the IC until after soldering



Soft Core Wires



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And fixing them!

Finding Errors

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Finding errors

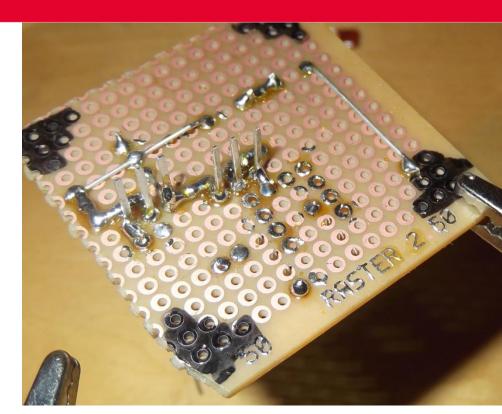
- Visual inspection
- Voltage measurements at critical points
- ♣ Follow the signal
- - Missing connections
 - Short circuits
 - Cold joints
 - Dry joints

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Visual Inspection

Clearly not finished

Fast and simple method to find faulty or missing connections

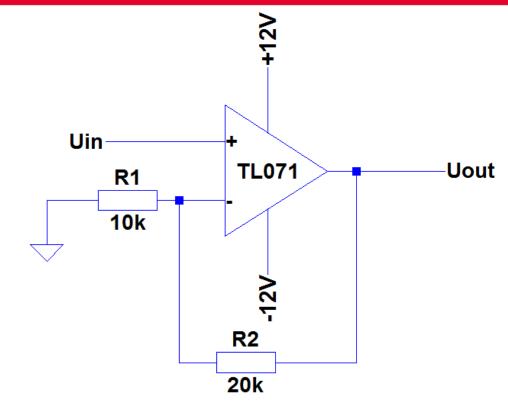




Voltage measurement

What voltages do you expect at every node?

- Then follow the signal through the circuit





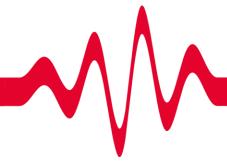
Fixing errors

Desoldering Pump



Desoldering Wick





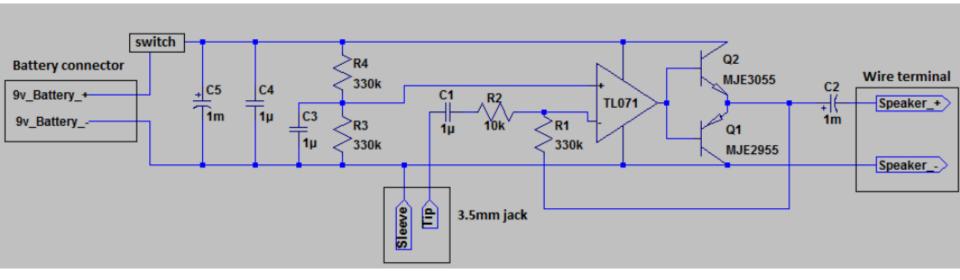
Audio Amplifier

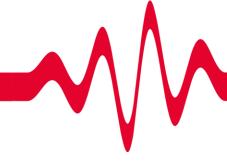
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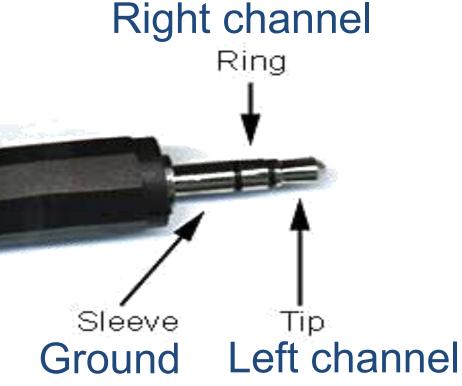
The Practical





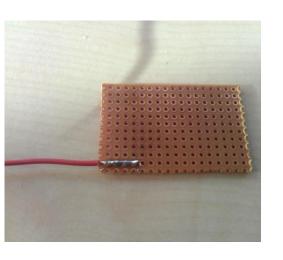
Jack Plug

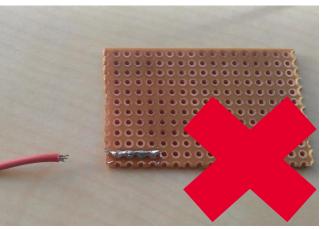
Mono amplifiers only use the *left* channel

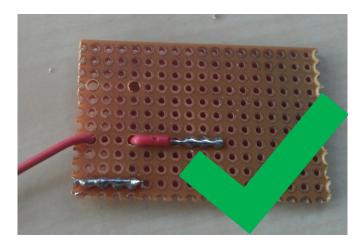


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Connecting the Jack





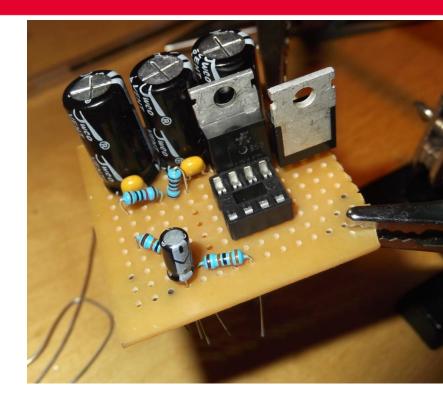


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Final Product

How to get here?

- Analyse the circuit diagram
- Make a layout on the PCB
- Insert the components and solder them



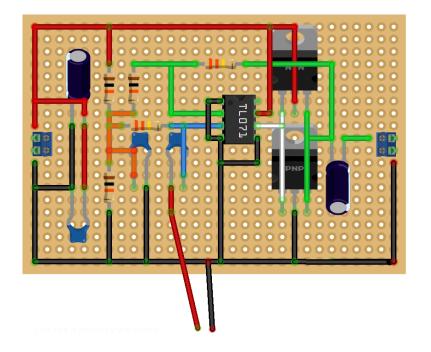


Final Product

- Taking the schematic and placing the components on the PCB is very time consuming
- This process will take (most of) the evening!
- We have therefore also made a layout for you if you just want to solder!

Soldering hints

- - PNP & NPN
 - Capacitor polarity

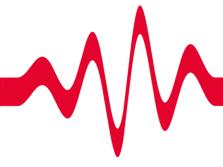




Documentation!

https://docs.scintilla.utwente.nl/masterclass/SolderingCourse2025





Good luck and happy soldering!

You can ask the MasterCLASS members for an example on how to solder a component. And all other questions ©